

CERAMIC FILTER



Approved by:

Checked by:

Issued by:

SPECIFICATION

P/N: LTCS10.7MS2GJM

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1 SCOPE

This specification shall cover the characteristics of the ceramic filter with the type LTCS10.7MS2GJM. The LTCS10.7MS2GJM filters are small, high performance and very thin (1.4mm) chip devices consisting of 2 ceramic elements for communication equipment. They are designed on MgTiO₃ ceramic cap package.

2 PART NO.

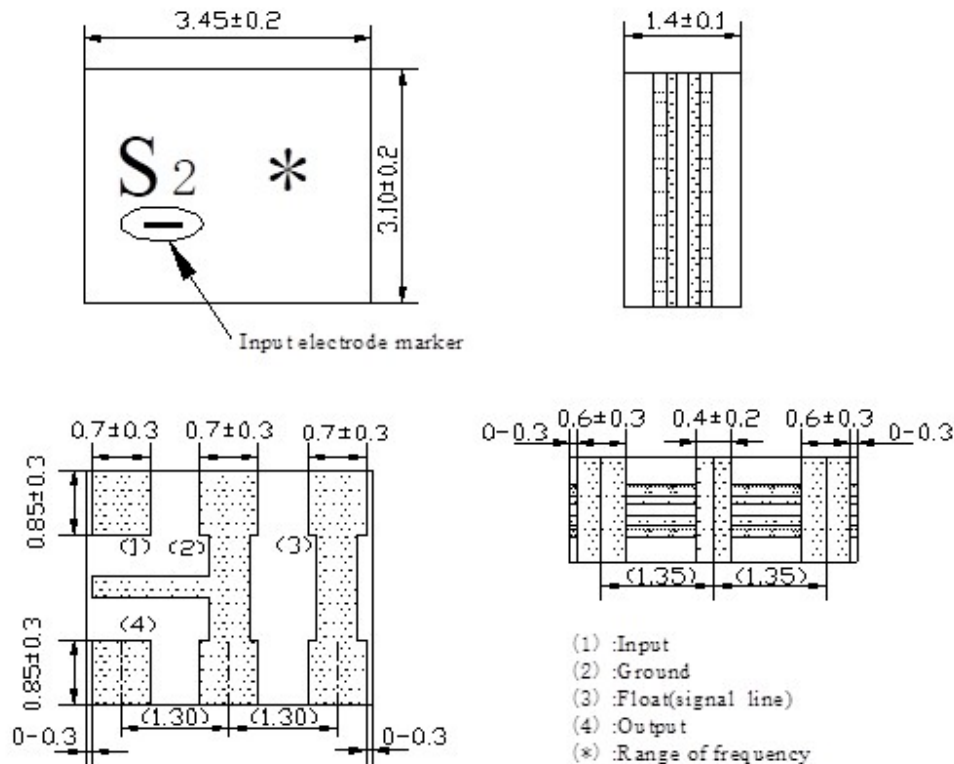
PART NUMBER	CUSTOMER PART NO.	SPECIFICATION NO.
LTCS10.7MS2GJM		

3 OUTLINE DRAWING

3.1 Appearance

No visible damage and dirt.

3.2 Dimensions (unit: mm)



The design, manufacturing process, and specifications of this device are subject to change without notice.

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4 ELECTRICAL SPECIFICATIONS

4.1 RATING

Items	Content
Withstanding Voltage (V)	50 (DC, 1min)
Insulation Resistance R_i , ($M\Omega$) min.	100 (100V, 1min)
Operating Temperature Range ($^{\circ}C$)	-25 $\sim$ +85
Storage Temperature Range ($^{\circ}C$)	-40 $\sim$ +85

4.2 ELECTRICAL SPECIFICATIONS

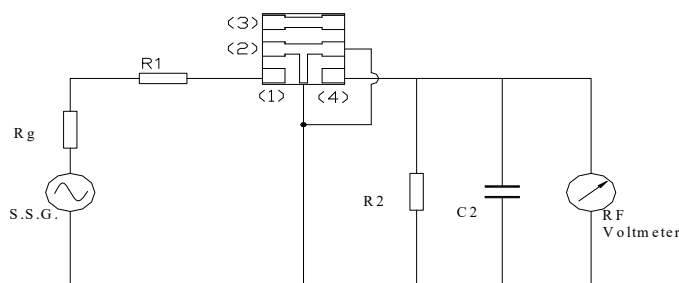
Items	Content
Center Frequency(f_o)(MHz)	10.700 $\pm$ 0.020
3dB Bandwidth(kHz)	230 $\pm$ 50
20dB Bandwidth(kHz) max	510
Insertion Loss (dB)	3.5 $\pm$ 2.0 (at minimum loss point)
Ripple (dB) max	1.0 (within 3dB Bandwidth)
Spurious Response (dB) min	30 (9MHz-12MHz)
Input/Output Impedance(Ω)	330

5 TESTS

5.1 Test Conditions

Parts shall be tested under a condition (Temperature:+20 $^{\circ}C$ $\pm$ 15 $^{\circ}C$, Humidity:65% $\pm$ 20%R.H.)unless the standard condition(Temperature:+25 $^{\circ}C$ $\pm$ 3 $^{\circ}C$,Humidity:65% $\pm$ 5% R.H.) is regulated to test.

5.2 Test Circuit:



$R1 + R_g = R2 = 330\Omega$
 $C2 = 10$ Pf (Including stray capacitance and capacitance of RF Voltmeter)
 S.S.G: Output Voltmeter

- ①:Input
- ②:Ground
- ③:Float
- ④:Output

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6 PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS

No	Item	Condition of Test		Performance Requirements
6.1	Humidity	Stored at $40^{\circ}\text{C} \pm 2^{\circ}\text{C}$, in 90%~95%R.H. for 96h, and left at room temp. for 1h before measurement.		It shall fulfill the specifications in Table 1.
6.2	High Temperature Exposure	Stored in $85^{\circ}\text{C} \pm 2^{\circ}\text{C}$ for 96h, and left at room temp. for 1h before measurement.		It shall fulfill the specifications in Table 1.
6.3	Low Temperature Exposure	Stored in $-40^{\circ}\text{C} \pm 3^{\circ}\text{C}$ for 96h, and left at room temp. for 1h before measurement.		It shall fulfill the specifications in Table 1.
6.4	Temperature Cycling	After temp. cycling of -40°C (30 min) to $+85^{\circ}\text{C}$ (30 min) was performed 5 times, filter shall be measured after being placed in natural condition for 1h .		
6.5	Soldering Test	Passed through the reflow oven under the following condition for 2 times, and left at room temp. for 24h before measurement.		
6.6	Solderability	Dipped in $235^{\circ}\text{C} \pm 5^{\circ}\text{C}$ solder bath for $3\text{s} \pm 0.5\text{s}$ with rosin flux.		The terminals shall be at least 95% covered by solder
		Temperature at the surface of the substrate	Time	
		Preheat $150^{\circ}\text{C} \pm 5^{\circ}\text{C}$	$60\text{s} \pm 10\text{s}$	
		Peak $235^{\circ}\text{C} \pm 5^{\circ}\text{C}$	$10\text{s} \pm 3\text{s}$	
6.7	Drop test	Free drop to the wood plate from the height of 70 cm for 3 times.		It shall fulfill the specifications in Table 1.
6.8	Vibration	Apply the vibration of sweep frequency 10 to 55Hz/minutes, amplitude 1.5mm, duration 2h in each direction of 3 planes.		It shall fulfill the specifications in Table 1.
6.9	Board Bending	Mount a glass-epoxy board (Width=40mm, thickness=1.6mm), then bend it to 1mm displacement and keep it for 5s. (See the following figure)		Mechanical damage such as breaks shall not occur.

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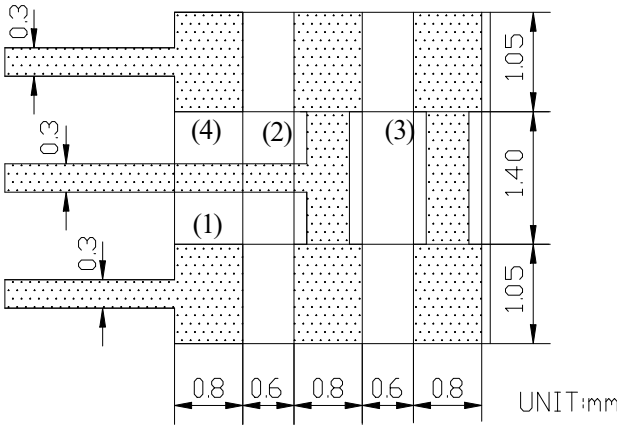


TABLE 1 SPECIFICATION AFTER TEST ABOUT CHARACTERISTICS

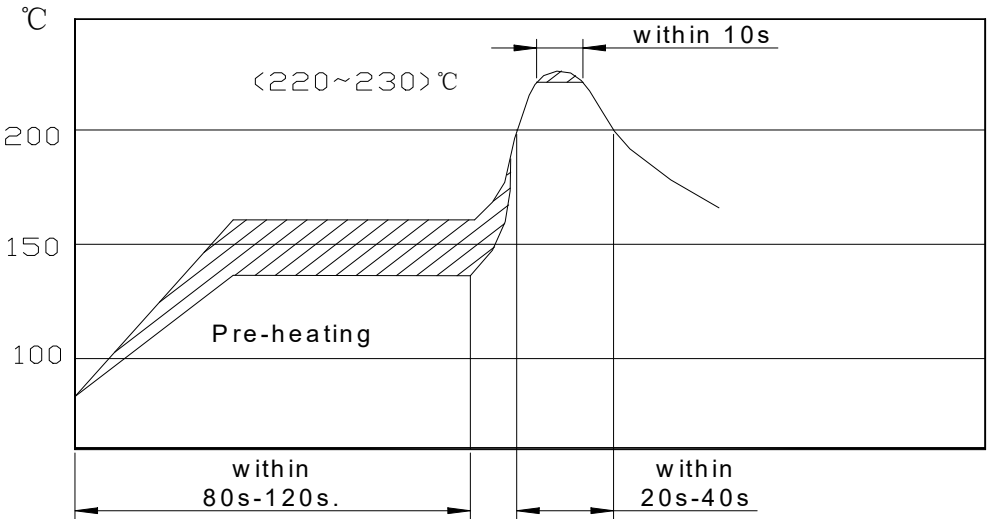
Item	Specification after test
Insertion Loss Drift (dB) max	± 2
3dB Bandwidth Drift (kHz) max	± 25
20dB Bandwidth Drift (kHz) max	± 60
Note : The limits in the above table are referenced to the initial measurements.	

7 RECOMMENDED LAND PATTERN AND REFLOW SOLDERING STANDARD CONDITIONS

7.1 Recommended land pattern



7.2 Recommended reflow soldering standard conditions



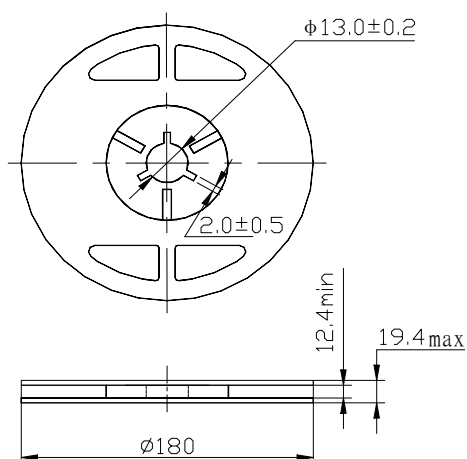
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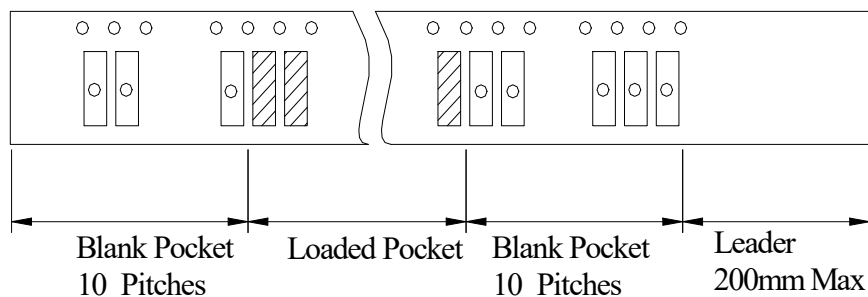
8 PACKAGE

Per plastic reel 1000 pieces of piezoelectric ceramic part

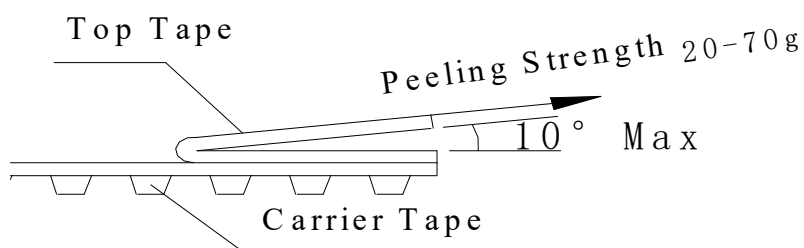
8.1 Reel



8.2 Packing Method Sketch Map



8.3 Test Condition of Peeling Strength



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9 OTHERS

9.1 Caution of use

9.1.1 Do not use this product with bend. Please don't apply excess mechanical stress to the component and terminals at soldering.

9.1.2 The component may be damaged when an excess stress will be applied.

9.1.3 Conformal coating of the component is acceptable, However the resin materials, curing temperature and other process conditions should be evaluated to conform stable electrical characteristics are maintained.

9.2 Notice

9.2.1 This specification mentions the quality of the component as a single unit. Please insure the component is thoroughly evaluated in your application circuit.

9.2.2 Please return one of this specification after your signature of acceptance.

9.2.3 When something gets doubtful with this specification, we shall jointly work to get an agreement.